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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR NP84N055ELE, NP84N055KLE NP84N055CLE, NP84N055DLE, NP84N055MLE, NP84N055NLE

## SWITCHING N-CHANNEL POWER MOS FET

#### DESCRIPTION

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

#### <R> ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	MACKAGE		
NP84N055ELE-E1-AY Note1, 2			TO-263 (MP-25ZJ) typ. 1.4 g		
NP84N055ELE-E2-AY Note1, 2		Tana 800 n/raal			
NP84N055KLE-E1-AY Note1	Pure Sn (Tin)	Tape 800 p/reel			
NP84N055KLE-E2-AY Note1			TO-263 (MP-25ZK) typ. 1.5 g		
NP84N055CLE-S12-AZ Note1, 2	Sn-Ag-Cu		TO-220 (MP-25) typ. 1.9 g		
NP84N055DLE-S12-AY Note1, 2		Tube 50 p/tube	TO-262 (MP-25 Fin Cut) typ. 1.8 g		
NP84N055MLE-S18-AY Note1	Pure Sn (Tin)		TO-220 (MP-25K) typ. 1.9 g		
NP84N055NLE-S18-AY Note1		<u> </u>	TO-262 (MP-25SK) typ. 1.8 g		

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Not for new design

## FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance
- $R_{DS(on)1} = 7.0 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 42 \text{ A})$
- RDS(on)2 = 8.7 m $\Omega$  MAX. (VGS = 5 V, ID = 42 A)
- $R_{DS(on)3} = 9.4 \text{ m}\Omega \text{ MAX}. (V_{GS} = 4.5 \text{ V}, \text{ ID} = 42 \text{ A})$
- Low input capacitance
- Ciss = 6130 pF TYP.
- Built-in gate protection diode



(TO-220)

(TO-262)



(TO-263)



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The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGS = 0 V)	VDSS	55	V
Gate to Source Voltage (VDs = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C) Note1	D(DC)	±84	А
Drain Current (pulse) Note2	D(pulse)	±336	Α
Total Power Dissipation (T <sub>A</sub> = 25°C)	Рт	1.8	W
Total Power Dissipation (Tc = $25^{\circ}$ C)	Рт	200	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	–55 to +175	°C
Single Avalanche Current Note3	las	84/55/20	Α
Single Avalanche Energy Note3	Eas	70/302/400	mJ

**Notes 1.** Calculated constant current according to MAX. allowable channel temperature.

**2.** PW  $\leq$  10  $\mu$ s, Duty cycle  $\leq$  1%

**3.** Starting  $T_{ch} = 25^{\circ}C$ ,  $V_{DD} = 28$  V,  $R_G = 25 \Omega$ ,  $V_{GS} = 20 \rightarrow 0$  V (See Figure 4.)

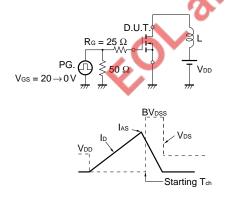
#### THERMAL RESISTANCE

THERIVIAL RESISTANCE			
Channel to Case Thermal Resistance	Rth(ch-C)	0.75	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W
		3	
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## ELECTRICAL CHARACTERISTICS (TA = 25°C)

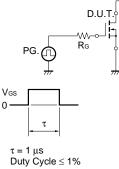
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = 55 V, V <sub>GS</sub> = 0 V			10	μA
Gate Leakage Current	lgss	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±10	μA
Gate to Source Threshold Voltage	$V_{\text{GS(th)}}$	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.5	2.0	2.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 42 A	27	58		S
Drain to Source On-state Resistance	RDS(on)1	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 42 A		5.6	7.0	mΩ
	RDS(on)2	V <sub>GS</sub> = 5 V, I <sub>D</sub> = 42 A		6.5	8.7	mΩ
	RDS(on)3	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 42 A		7.0	9.4	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 25 V,		6130	9200	pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V,		710	1070	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		350	630	pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = 28 V, I <sub>D</sub> = 42 A,	S.	29	64	ns
Rise Time	tr	Vgs = 10 V,		19	47	ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 1 Ω		120	230	ns
Fall Time	tr			21	53	ns
Total Gate Charge	Q <sub>G1</sub>	V <sub>DD</sub> = 44 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 84 A		120	180	nC
	Q <sub>G2</sub>	Vdd = 44 V,		65	98	nC
Gate to Source Charge	QGS	Vgs = 5 V,		18		nC
Gate to Drain Charge	Qgd	ID = 84 A		33		nC
Body Diode Forward Voltage	VF(S-D)	I⊧ = 84 A, V₀s = 0 V		1.0		V
Reverse Recovery Time	trr	I⊧ = 84 A, V₀s = 0 V,		49		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		78		nC

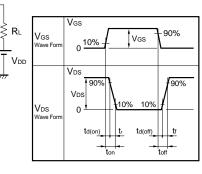
## TEST CIRCUIT 1 AVALANCHE CAPABILITY



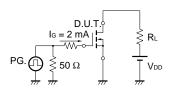
## **TEST CIRCUIT 2 SWITCHING TIME**

} R∟ }

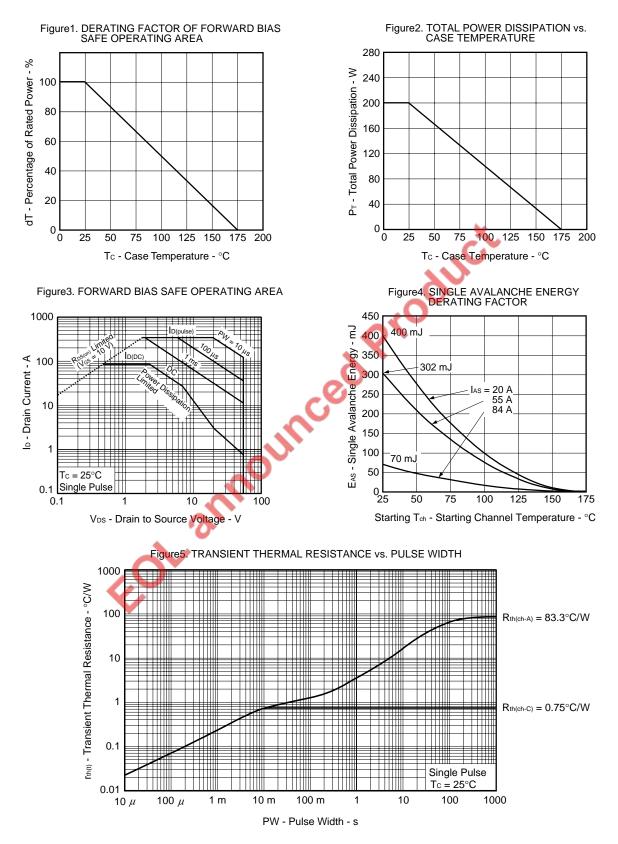




### **TEST CIRCUIT 3 GATE CHARGE**

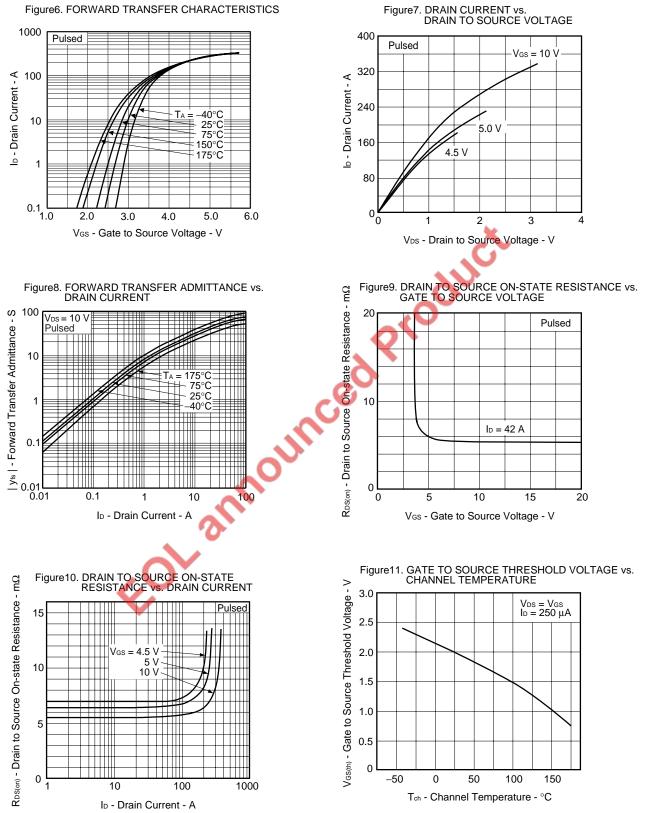


## TYPICAL CHARACTERISTICS (TA = 25°C)

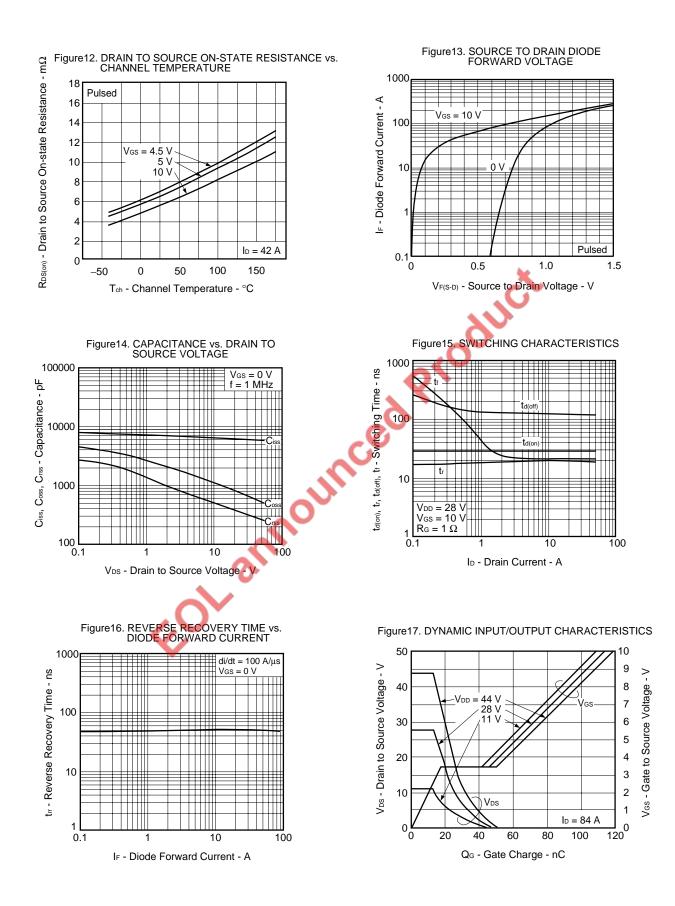


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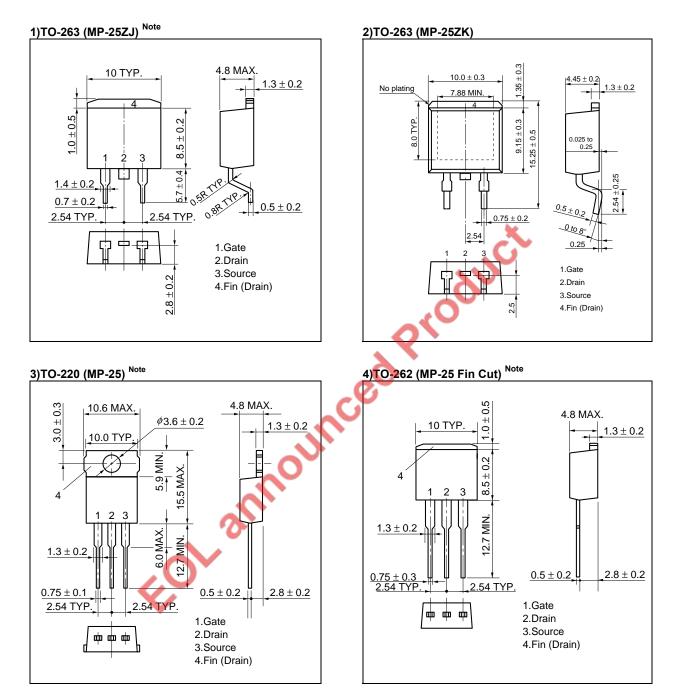
Figure6. FORWARD TRANSFER CHARACTERISTICS



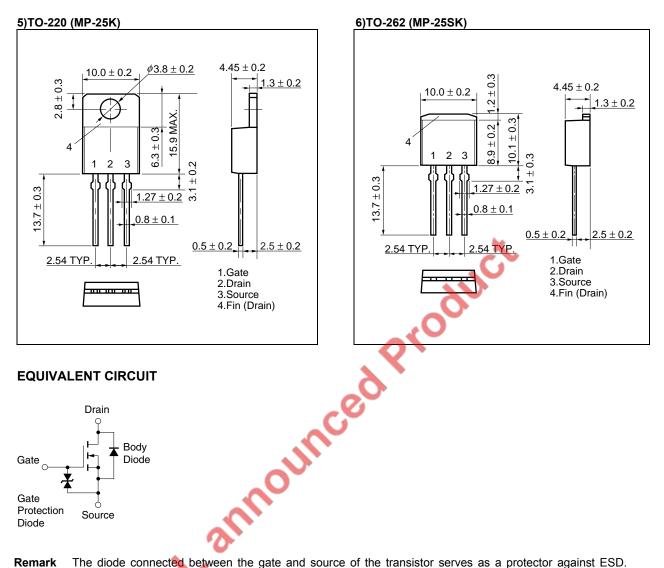
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## <R> PACKAGE DRAWINGS (Unit: mm)



Note Not for new design

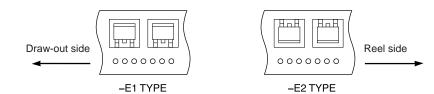


**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

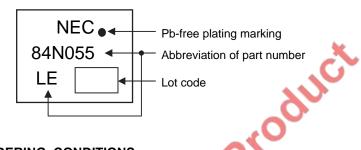
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### <R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



#### <R> MARKING INFORMATION



#### <R> RECOMMENDED SOLDERING CONDITIONS

These products should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol	
Infrared reflow MP-25ZJ, MP-25ZK	Maximum temperature (Package's surface temperature): 260°C or below Time at maximum temperature: 10 seconds or less Time of temperature higher than 220°C: 60 seconds or less Preheating time at 160 to 180°C: 60 to 120 seconds	IR60-00-3	
·	Maximum number of reflow processes: 3 times Maximum chlorine content of rosin flux (percentage mass): 0.2% or less		
Wave soldering MP-25, MP-25K, MP-25SK, MP-25 Fin Cut	Maximum temperature (Solder temperature): 260°C or below Time: 10 seconds or less Maximum chlorine content of rosin flux: 0.2% (wt.) or less	THDWS	
Partial heating MP-25ZJ, MP-25ZK, MP-25K, MP-25SK	Maximum temperature (Pin temperature): 350°C or below Time (per side of the device): 3 seconds or less Maximum chlorine content of rosin flux: 0.2% (wt.) or less	P350	
Partial heating MP-25, MP-25 Fin Cut	Maximum temperature (Pin temperature): 300°C or below Time (per side of the device): 3 seconds or less Maximum chlorine content of rosin flux: 0.2% (wt.) or less	P300	

Caution Do not use different soldering methods together (except for partial heating).

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